

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	)	
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<b>Shigeki MORI et al.</b>	)	Art Unit: <b>1796</b>
	)	
Serial No. <b>10/564,843</b>	)	
<b>(National Phase of PCT/JP2004/010549)</b>	)	Examiner: <b>Zimmer, Marc S.</b>
	)	
Filed: <b>January 13, 2006</b>	)	
	)	
For: <b>Curable Resin Composition and</b>	)	
<b>Cold-Setting Adhesive</b>	)	Attorney Docket No.: 44471/324817

I hereby certify that this submission is being  
filed via EFS Web to the U. S. Patent and  
Trademark Office on March 9, 2009.

/Melody T. Wilson/  
Melody T. Wilson

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**AMENDMENT AND RESPONSE TO OFFICE ACTION**

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Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Responsive to the final Office Action dated January 9, 2009 in the patent application identified above, please enter the following amendments and reconsider the application in light of the appended remarks.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 4 of this paper.